





Features

- Planar Die Construction
- General Purpose, Medium Current
- Ideally Suited for Automated Assembly Processes
- Lead, Halogen and Antimony Free, RoHS Compliant "Green" Device (Notes 1, 2 and 6)

Mechanical Data

- Case: SOD-323
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin annealed over Alloy 42 leadframe. Solderable per MIL-STD-202, Method 208
- Marking & Type Code Information: See Electrical Specifications Table
- Ordering Information: See Page 3
- Weight: 0.004 grams (approximate)

SOD-323					
Dim	Min Max				
Α	2.30	2.70			
В	1.60 1.80				
C	1.20 1.40				
D	1.05 Typical				
E	0.25	0.35			
G	0.20	0.40			
Н	0.10 0.15				
J	0.05 Typical				
α	0°	8°			
All Dimensions in mm					

Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit	
Forward Voltage	@ I _F = 10mA	V _F	0.9	V
Operating and Storage Temperature Range		T _{J,} T _{STG}	-65 to +150	°C

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 3)	P _D	200	mW
Thermal Resistance, Junction to Ambient Air (Note 3)	$R_{ heta JA}$	833	°C/W

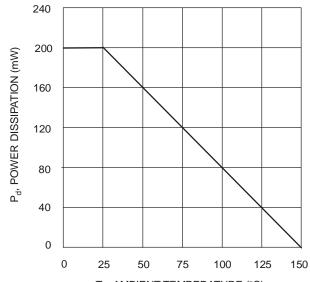
Electrical Characteristics @T_A = 25°C unless otherwise specified

Type Number	Marking Code (Note 4)	Zener Voltage Range (Note 3)			Maximum Zener Impedance (Note 5)			Maximum Reverse Current (Note 5)		
	(11010-1)		Vz @ I _{ZT}		I _{ZT}	Z _{ZT} @ I _{ZT}	Z _{ZK} @ I _{ZK}	Izk	I_R	@ V R
		Nom (V)	Min (V)	Max (V)	mA	Ω mA		uA	٧	
BZT52C51S	WW	51	48.0	54.0	5	100	750	1.0	0.1	38

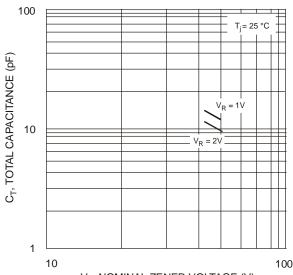
Notes:

- 1. No purposefully added lead. Halogen and Antimony Free.
- 2. Diodes Inc's "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php
- Short duration pulse test used to minimize self-heating effect.
- 4. When provided, otherwise, parts are provided with date code only, and type number identification appears on reel only.
- 6. Product manufactured with Green Molding Compound and does not contain Halogens or Sb₂O₃ Fire Retardants.





 $\rm T_A, AMBIENT \, TEMPERATURE \, (^{\circ}C)$ Fig. 1 Power Dissipation vs Ambient Temperature



 $\label{eq:VZ} {\rm V_{Z},\,NOMINAL\,\,ZENER\,\,VOLTAGE\,\,(V)}$ Fig. 3 Total Capacitance vs Nominal Zener Voltage

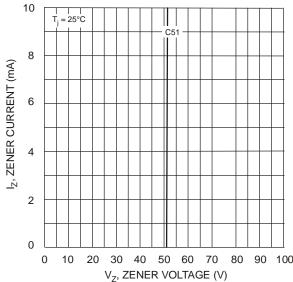


Fig. 2 Zener Breakdown Characteristics



Ordering Information (Note 7)

Device	Packaging	Shipping
BZT52C51S-7	SOD-323	3000/Tape & Reel

Notes:

7. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



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